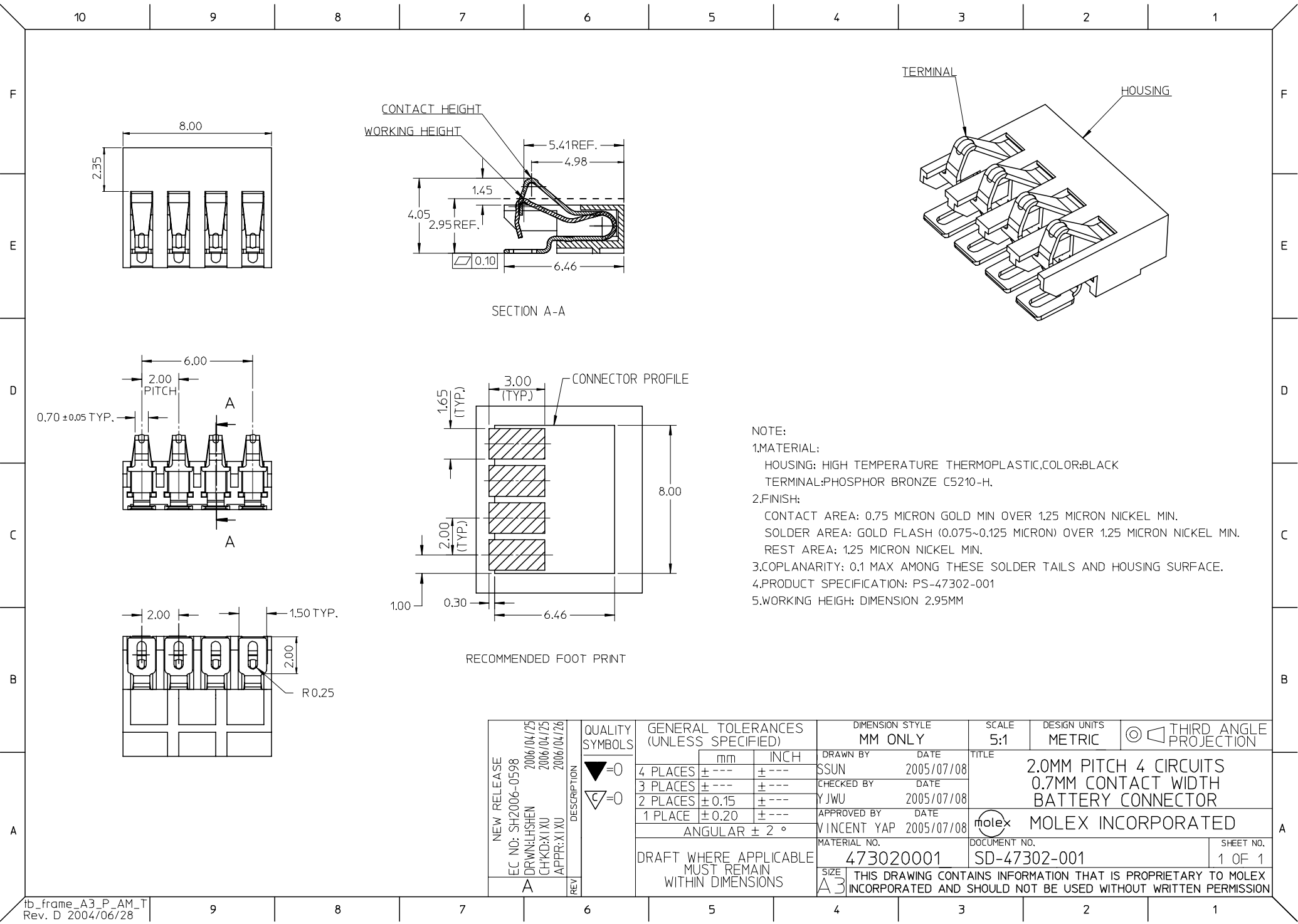




NOTE:
1.MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC,COLOR:BLACK
TERMINAL:PHOSPHOR BRONZE C5210-H.
2.FINISH:
CONTACT AREA: 0.75 MICRON GOLD MIN OVER 1.25 MICRON NICKEL MIN.
SOLDER AREA: GOLD FLASH (0.075~0.125 MICRON) OVER 1.25 MICRON NICKEL MIN.
REST AREA: 1.25 MICRON NICKEL MIN.
3.COPLANARITY: 0.1 MAX AMONG THESE SOLDER TAILS AND HOUSING SURFACE.
4.PRODUCT SPECIFICATION: PS-47302-001
5.WORKING HEIGH: DIMENSION 2.95MM

NEW RELEASE EC NO: SH2006-0598 DRWN:LJSHEN CHKD:XIXU APPR:XIXU A	DESCRIPTION	QUALITY SYMBOLS ▽=0 ◇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY	DATE	TITLE 2.0MM PITCH 4 CIRCUITS 0.7MM CONTACT WIDTH BATTERY CONNECTOR				
			4 PLACES	± ---	± ---	SSUN	2005/07/08					
			3 PLACES	± ---	± ---	CHECKED BY	DATE					
			2 PLACES	± 0.15	± ---	YJWU	2005/07/08	MOLEX MOLEX INCORPORATED				
	1 PLACE	± 0.20	± ---	APPROVED BY	DATE	MATERIAL NO. 473020001						
ANGULAR ± 2 °			VINCENT YAP		2005/07/08						DOCUMENT NO. SD-47302-001	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
REV	SHEET NO. 1 OF 1											